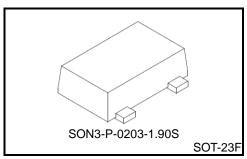
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TCS40DPR

Digital Output Magnetic Sensor

Feature

Push-Pull Output
South-Pole and North-Pole Detection

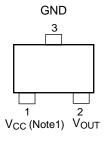


Weight: 11.0 mg (typ.)

Marking



Pin Assignment (Top View)



Function Table

Magnetic Flux Density	Output		
$\geq B_{ON}$	L		
≤ Boff	Н		

Note 1: A 0.47 μ F capacitor should be connected near the device. This condition will not guarantee successful operation. Check the performance thorough evaluation using the actual application to set the condition.

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply Voltage	Vcc -0.5 to 6.0		V
Output Voltage	Vout	−0.5 to 6.0	V
Output Diode Current	lok	±10	mA
Output Current	lout	±5	mA
Vcc/GND Current	Icc	±10	mA
Power Dissipation	PD	1 (Note 2)	W
Storage Temperature Range	T _{stg}	−65 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Operating Ranges

Characteristics	Symbol	Rating	Unit
Supply Voltage	Vcc	2.3 to 5.5	V
Output Voltage	Vout	0 to V _{CC}	V
Output Current	IOH / IOL	±1.0	mA
Operating Temperature	Topr	-40 to 85	°C

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DC Characteristics (Ta = 25°C)

Characteri	stics	Symbol	Condition	V _{CC} (V)	Min	Тур.	Max	Unit
	High Level	Vон	I _{OH} = −1.0 mA	2.3	2.0	_	-	
				2.5	2.2	1	1	
				3.3	2.9	1	1	
				3.6	3.2	-	-	
Output Voltage				5.0	4.5	1	1	V
Output Voltage		VoL	I _{OL} = 1.0 mA	2.3	_	1	0.23	V
				2.5	_	1	0.25	
	Low Level			3.3	_	1	0.33	
				3.6	_	1	0.36	
				5.0	_	_	0.50	
	Average Current	Icc	Current at pulse driving (Note 3, Fig. A)	2.3	_	7.3	13.2	μΑ
Supply Current				2.5	_	8.5	_	
				3.3	_	12.8	1	
				5.0	_	19.0	_	
	Operating Current	IccON	Peak current (Note 3, Fig. A)	2.3	_	0.7	1.1	mA
				2.5	_	0.8	-	
				3.3	_	1.2	_	
				5.0	_	1.6	_	
Operating Fre	quency	fopr	(Fig. A)	2.3 to 5.0	_	25	_	Hz

Note 3: Supply current is pulsed periodically by internal circuit.

Magnetic Characteristics (Ta = 25°C)

Cha	aracteristics	Symbol	Condition (Note 4, Fig. B)	V _{CC} (V)	Min	Тур.	Max	Unit
Magnetic Flux Density, B	Operating Daint	BonS	When output logic turns High to Low	2.3 to 3.6	_	3.4	4.4	
	Operating Point	BonN		5.0	_	2.8	4.4	
	Releasing Point	BOFFS	When output logic turns Low to High	2.3 to 3.6	0.9	2.0	_	mT*
		B _{OFF} N		5.0	0.4	1.5	_	
	Hysteresis	BH	Bon - Boff	2.3 to 5.0	_	1.4	_	

*1 mT = 10 Gauss

Note 4: Uniform magnetic field perpendicularly to the magnetic sensor.

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Note: Direction of Magnetic field

Magnetic Field, B

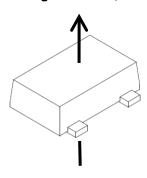


Fig. A: Icc Characteristics

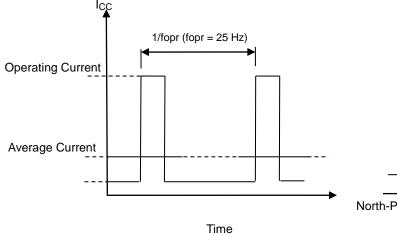
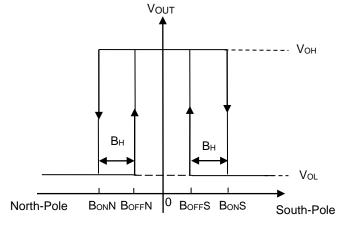


Fig. B: Operating Characteristics

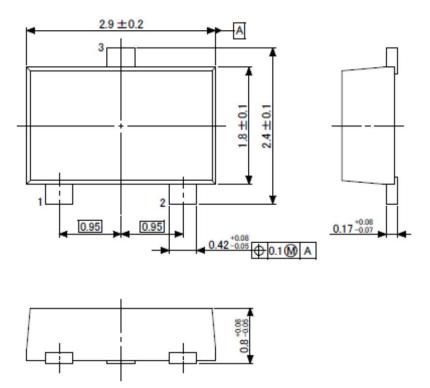


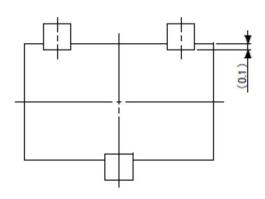
Magnetic Flux Density

Package Dimension

SON3-P-0203-1.90S

Unit: mm

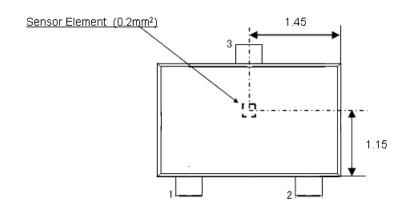


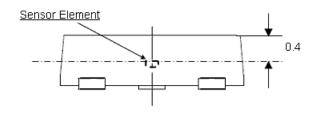


Weight: 11.0 mg (Typ.)

Layout of Sensor Element

Unit: mm





Note: Dimensional tolerances are ±0.1 mm, unless otherwise specified.

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